

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>SANG HEE LEE</td><td>08/21/2007</td></tr><tr><td>GAB HWAN CHO</td><td>08/21/2007</td></tr></tbody></table>	Name	Execution Date	SANG HEE LEE	08/21/2007	GAB HWAN CHO	08/21/2007	
Name	Execution Date						
SANG HEE LEE	08/21/2007						
GAB HWAN CHO	08/21/2007						
RECEIVING PARTY DATA							
Name:	DONGBU HITEK CO., LTD.						
Street Address:	891-10 DAECHI-DONG, GANGNAM-GU						
City:	SEOUL						
State/Country:	KOREA, REPUBLIC OF						
Postal Code:	135-280						
PROPERTY NUMBERS Total: 1							
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11842876</td></tr></tbody></table>	Property Type	Number	Application Number:	11842876			
Property Type	Number						
Application Number:	11842876						
CORRESPONDENCE DATA							
Fax Number:	(352)372-5800						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
Phone:	352-375-8100						
Email:	JL@SLSPATENTS.COM						
Correspondent Name:	JEFF LLOYD						
Address Line 1:	PO BOX 142950						
Address Line 4:	GAINESVILLE, FLORIDA 32614-2950						
ATTORNEY DOCKET NUMBER:	SUN-DH-422						
NAME OF SUBMITTER:	Jeff Lloyd						
Total Attachments: 2 source=recorded-assignment#page1.tif source=recorded-assignment#page2.tif							

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PATENT  
REEL: 019928 FRAME: 0885

Assignment-50599

Docket No. SUN-DH-311

ASSIGNMENT

WHEREAS, we, the undersigned, residing at the indicated addresses given below, respectively, have invented certain new and useful improvements in **A LAYOUT METHOD FOR MASK**, for which an application for United States Letters Patent was filed 08/21/2007, as Serial No. 11/842,876.

WHEREAS, **DONGBU HITEK CO., LTD.**, a corporation of the country of the **Republic of Korea**, having a place of business at **891-10 Daechi-dong, Gangnam-gu, Seoul 135-280, Republic of Korea** is desirous of acquiring the entire right, title, and interest in and to said invention and in and to any Letters Patent which may be granted therefor in the United States and in any and all foreign countries;

NOW, THEREFORE, in view of valuable consideration, receipt of which is hereby acknowledged, we, the undersigned, have sold, assigned, and transferred, and by these presents do sell, assign, and transfer, unto said **DONGBU HITEK CO., LTD.**, its successors and assigns, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title, and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, and extensions thereof.

We hereby authorize and request the Patent Office Officials in the United States and in any and all foreign countries to issue any and all of said Letters Patent, when granted, to **DONGBU HITEK CO., LTD.**, as the assignee of the entire right, title, and interest in and to the same, for the sole use and behoof of said **DONGBU HITEK CO., LTD.**, its successors and assigns.

FURTHER, we agree that we will communicate to said **DONGBU HITEK CO., LTD.**, or its representatives, any facts known to us respecting said invention; testify in any legal proceedings; sign all lawful papers; execute all divisional, continuation, substitution, renewal, and reissue applications; execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said **DONGBU HITEK CO., LTD.**; make all rightful oaths; and generally do everything possible to aid the said **DONGBU HITEK CO., LTD.**, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, I have hereunto set my hand this 21<sup>th</sup> day of Aug., 2007.

Signature: Sang Hee Lee  
**LEE, Sang Hee**  
332-2, Eubnae1-ri, Eumseong-eub,  
Eumseong-goon,  
Choongcheongbook-do, Republic of Korea

Signature: G. H. Cho  
**CHO, Gab Hwan**  
472, Sadong4-ri, Daewol-myeon, Echeon-si,  
Gyeonggi-do, Republic of Korea

WITNESS: Y. K. Jang

Signature: Jung

Printed Name: Yoon Kyung JUNG

Date: August 21, 2007